503796691 04/23/2016

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3843338

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TSUNG-YI HUANG	04/18/2016

RECEIVING PARTY DATA

Name:	RICHTEK TECHNOLOGY CORPORATION	
Street Address:	14F., NO.8, TAIYUAN 1ST ST.	
City:	ZHUBEI CITY, HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15136917

CORRESPONDENCE DATA

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Correspondent Name: TUNG & ASSOCIATES / RANDY W. TUNG, ESQ.

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ATTORNEY DOCKET NUMBER: 92,000-498 (RH-1357)

NAME OF SUBMITTER: RANDY W TUNG

SIGNATURE: /Randy W Tung/

DATE SIGNED: 04/23/2016

Total Attachments: 1

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PATENT REEL: 038362 FRAME: 0830

503796691

Application NO.: 15/136,917

92000-498

RH-1357 V104-048

ASSIGNMENT

WHEREAS, I/we, Tsung-Yi Huang have invented certain improvements in:

"COMPLEMENTARY METAL OXIDE SEMICONDUCTOR DEVICE WITH DUAL-WELL AND MANUFACTURING METHOD THEREOF"

for which I am/we are about to make application for Letters Patent of the United States; and WHEREAS, Richtek Technology Corporation, a company having a business address residing in R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, Tsung-Yi Huang by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the following execution date, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

I/we further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and I/we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

Tsung-Yi Huang 2016/04/18 (Signature by first inventor/assignor) (Date)

TUNG & ASSOCIATES 838 W. Long Lake Road, Suite 120

Bloomfield Hills, Michigan 48302

PATENT REEL: 038362 FRAME: 0831

RECORDED: 04/23/2016